SQS166ELNW

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Vishay Siliconix

Automotive N-Channel 60 V (D-S) 175 °C MOSFET



Marking code: Q070

PRODUCT SUMMARY				
V _{DS} (V)	60			
$R_{DS(on)}$ (Ω) at V_{GS} = 4.5 V	0.0180			
$R_{DS(on)} (\Omega)$ at $V_{GS} = 10 V$	0.0089			
I _D (A) ^a	71			
Configuration	Single			

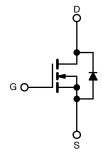
FEATURES

- TrenchFET[®] Gen IV power MOSFET
- AEC-Q101 qualified
- 100 % R_g and UIS tested
- Wettable flank terminals
- Low thermal resistance with 0.75 mm profile



AUTOMOTIVE

 Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



N-Channel MOSFET

ORDERING INFORMATION	
Package	PowerPAK 1212-8SLW
Lead (Pb)-free and halogen-free	SQS166ELNW (for detailed order number please see <u>www.vishay.com/doc?79776</u>)

ABSOLUTE MAXIMUM RATINGS ($T_c = 25 \degree C$, unless otherwise noted)					
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-source voltage		V _{DS}	60	N	
Gate-source voltage		V _{GS} ± 20		V	
Continuous drain current ^a	T _C = 25 °C	I	71		
Continuous drain current "	T _C = 125 °C	I _D	41		
Continuous source current (diode conduction) ^a		I _S	83	А	
Pulsed drain current ^{a, b}		I _{DM}	156		
Single pulse avalanche current	L = 0.1 mH	I _{AS}	19		
Single pulse avalanche energy		E _{AS}	18	mJ	
Maximum power dissipation ^{a, b}	T _C = 25 °C	D	91	w	
	T _C = 125 °C	P _D	30		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +175	°C	
Soldering recommendations (peak temperature) ^c			260	C	

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-ambient	PCB mount d	R _{thJA}	54	°C/W	
Junction-to-case (drain) ^e		R _{thJC}	1.64	0/10	

Notes

a. Values based on RthJC and TC of 25 °C. Actual values achievable will be dependent on the thermal characteristics of the complete system

b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

c. See solder profile (<u>www.vishay.com/doc?73257</u>). A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

d. When mounted on 1" square PCB (FR4 material)

e. As per on JESD51-14

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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static								
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0, I_D = 250 \ \mu A$		60	-	-	v	
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$		1.5	2.0	2.5	v	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$		-	-	± 100	nA	
Zero gate voltage drain current		$V_{GS} = 0 V$	V _{DS} = 60 V	-	-	1		
	I _{DSS}	$V_{GS} = 0 V$	$V_{DS} = 60 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$	-	-	50	μA	
		$V_{GS} = 0 V$	V _{DS} = 60 V, T _J = 175 °C	-	-	150		
On-state drain current ^a	I _{D(on)}	V _{GS} = 10 V	$V_{DS} \ge 5 V$	15	-	-	Α	
		V _{GS} = 4.5 V	I _D = 10 A	-	0.0130	0.0180		
	-	V _{GS} = 10 V	I _D = 10 A	-	0.0075	0.0089	-	
Drain-source on-state resistance ^a	R _{DS(on)}	V _{GS} = 10 V	I _D = 10 A, T _J = 125 °C	-	-	0.0144	Ω	
		V _{GS} = 10 V	I _D = 10 A, T _J = 175 °C	-	-	0.0180		
Forward transconductance b	9 _{fs}	V _{DS}	= 15 V, I _D = 20 A	-	55	-	S	
Dynamic ^b								
Input capacitance	C _{iss}		V _{DS} = 25 V, f = 1 MHz	-	1278	1790	pF	
Output capacitance	Coss	$V_{GS} = 0 V$		-	468	656		
Reverse transfer capacitance	C _{rss}			-	30	42		
Total gate charge ^c	Qg			-	21	32		
Gate-source charge ^c	Q _{gs}	V _{GS} = 10 V V	V V _{DS} = 30 V, I _D = 3 A	-	4	-	nC	
Gate-drain charge ^c	Q _{gd}			-	4	-	-	
Gate resistance	Rg		f = 1 MHz	0.4	1.2	2.0	Ω	
Turn-on delay time ^c	t _{d(on)}			-	9	14		
Rise time ^c	t _r	Voo :	= 30 V, R _L = 10 Ω	-	3	6		
Turn-off delay time ^c	t _{d(off)}	$I_D \cong 3 \text{ A}, \text{V}_{\text{GEN}} = 10 \text{ V}, \text{R}_{\text{g}} = 1 \Omega$		-	20	30	- ns	
Fall time ^c	t _f			-	6	9		
Source-Drain Diode Ratings and Charac	teristic ^b							
Pulsed current ^a	I _{SM}			-	-	156	A	
Forward voltage	V _{SD}	I _F = 10 A, V _{GS} = 0 V		-	0.82	1.1	V	
Body diode reverse recovery time	t _{rr}	V_{DD} = 48 V, I _F = 3.0 A, di/dt = 100 A/μs, R = 10 Ω, L = 0.3 mH, pulse width = 2 μs		-	35	70	ns	
Body diode reverse recovery charge	Q _{rr}			-	22	44	nC	
Reverse recovery fall time	t _a			-	13	-	<u> </u>	
Reverse recovery rise time	t _b			-	22	-	ns	
Body diode peak reverse recovery current	I _{RM(REC)}			_	-1.1	-	A	

Notes

a. Pulse test; pulse width $\leq 300~\mu\text{s},$ duty cycle $\leq 2~\%$

b. Guaranteed by design, not subject to production testing

c. Independent of operating temperature

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

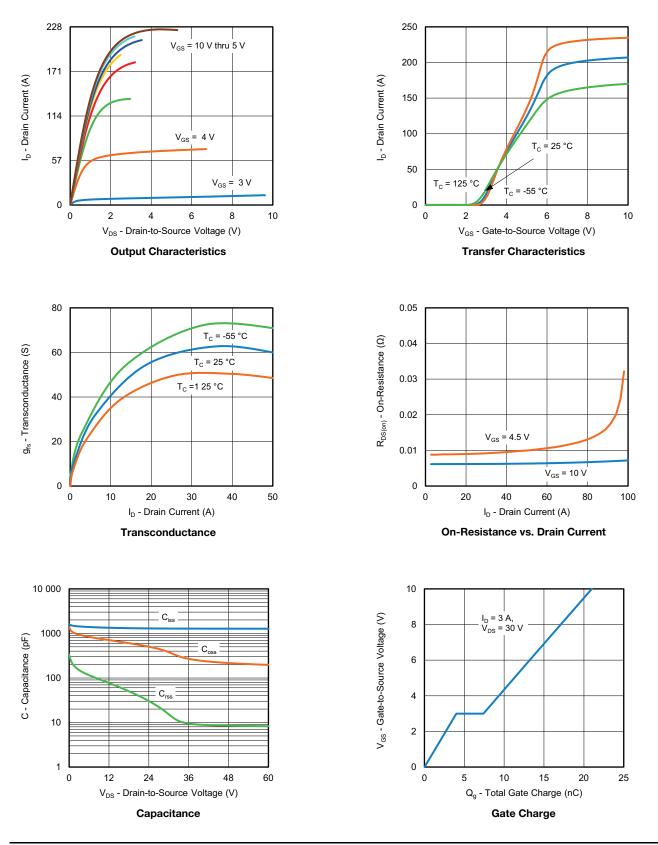
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TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



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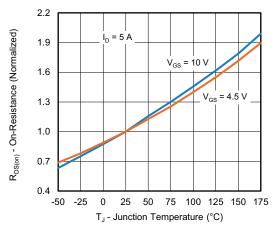
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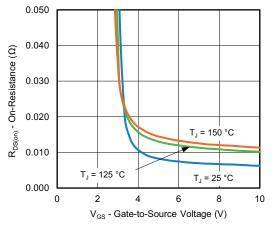


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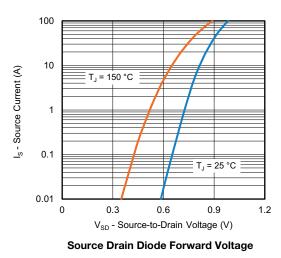
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On-Resistance vs. Junction Temperature

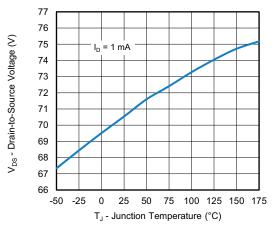


On-Resistance vs. Gate-to-Source Voltage

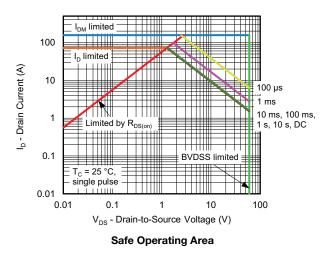


0.1 V_{GS(th)} - Variance (V) -0.2 = 5 mA -0.5 I_D = 250 μÅ -0.8 -1.1 -50 -25 0 25 50 75 100 125 150 175 T_{.I} - Junction Temperature (°C) **Threshold Voltage**

0.4



Drain Source Breakdown vs. Junction Temperature



Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

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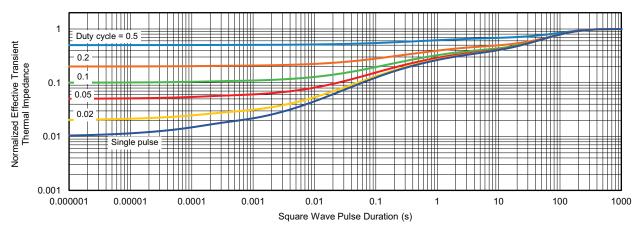
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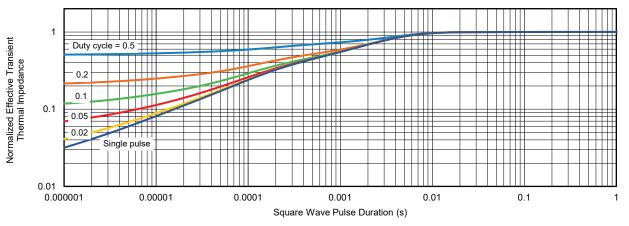


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THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?62139.

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